



PTC thermistors for degaussing

Dual PTC thermistors

Series/Type: B59***
Date: March 2006

Degaussing

Dual PTC thermistors

Applications

- Degaussing of picture tubes

Features

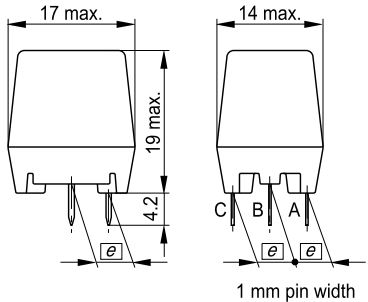
- Two PTC thermistors in a plastic case (3-pin)
- Low residual current through coil due to double PTC configuration
- Marked with manufacturer's logo, type designation and date code
- Flame-retardant case material (UL 94 V-0)
- Solderability to IEC 60068-2-20 (test t_a , methode 1)
- Stable performance throughout a large number of switching cycles owing to clamp contacting
- VDE approval for T209, T709, T104, T704, T108, T608 and T250 (license number 128911)
- UL approval for T705 and T709 to UL 1434 (file number E69802)
- CECC 60738-1-3-001 approval
- RoHS-compatible

Delivery mode

- Packed in blister trays

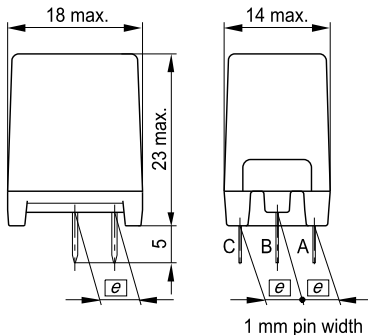
Dimensional drawings

Thermoplast housing for type:
T104, T108, T209, T250



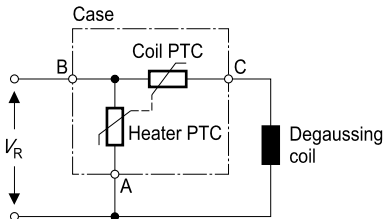
TPT0661-V-E

Phenolic resin (Duroplast) housing for type:
T608, T704, T705, T709



TPT0666-2-E

Circuit diagram

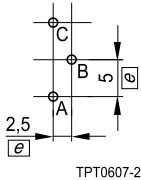


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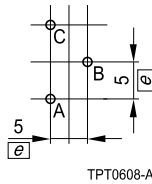
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Hole arrangement A



Hole arrangement B



General technical data

Max. operating voltage	V_{max}	270	VAC
Rated voltage	V_R	230	VAC
Operating temperature range ($V = 0$)	T_{op}	-25/+125	°C
Operating temperature range ($V = V_R$)	T_{op}	0/+60	°C

Electrical specifications and ordering codes

Type	R_R Ω	R_{coil} Ω	$I_{in,coil}$ (0 s) A_{pp}	$I_{r,coil}$ (180 s) ($V = V_R$, $25\text{ °C} \leq T_{op} \leq 60\text{ °C}$) mA_{pp}	Housing ¹⁾	Decay ²⁾	Ordering code
Hole arrangement = A							
T209	9	≥ 20	≥ 18	≤ 8	T	SD	B59209T0080A010
T709	9	≥ 14	≥ 24	≤ 4	D	LD	B59709T0060A110
T704	14	≥ 10	≥ 25	≤ 4	D	LD	B59704T0080A110
T108	18	≥ 10	≥ 20	≤ 4	T	SD	B59108T0080A010
T608	18	≥ 10	≥ 20	≤ 3	D	LD	B59608T0080A110
T250	28	≥ 25	≥ 10	≤ 4	T	-	B59250T0080A010
Hole arrangement = B							
T705	4.5	≥ 20	≥ 24	≤ 5	D	-	B59705T0060B110
T209	9	≥ 20	≥ 18	≤ 8	T	SD	B59209T0080B110
T709	9	≥ 14	≥ 24	≤ 4	D	LD	B59709T0060B110
T104	14	≥ 10	≥ 25	≤ 7	T	SD	B59104T0080B010
T108	18	≥ 10	≥ 20	≤ 4	T	SD	B59108T0080B010
T608	18	≥ 10	≥ 20	≤ 3	D	LD	B59608T0080B110

1) T: Thermoplast housing; D: Phenolic resin (Duroplast) housing

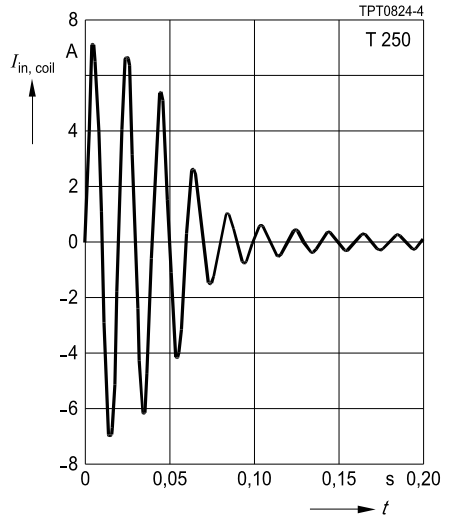
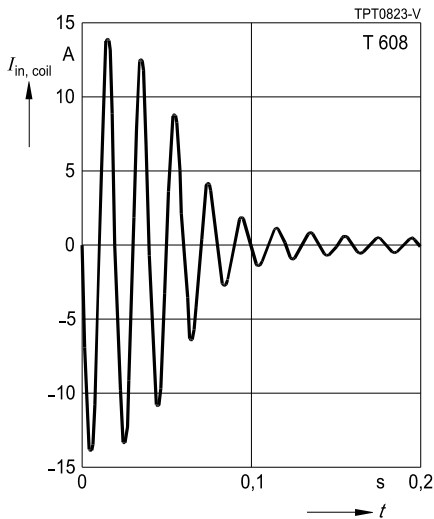
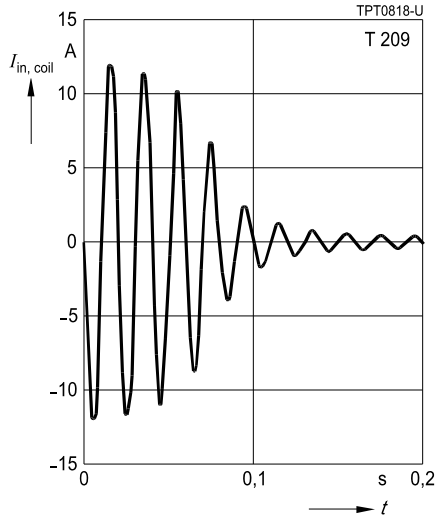
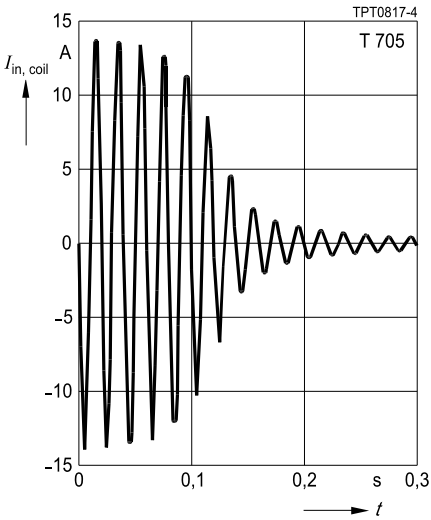
2) SD: Standard decay behavior; LD: Long decay behavior

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Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance, cycling	IEC 60738-1	Room temperature, V_{\max} ; R_S Number of cycles: 10 000	< 20%
Electrical endurance, constant	IEC 60738-1	Storage at V_{\max}/T_{op} Test duration : 1000 h	< 20%
Damp heat	IEC 60738-1	Temperature of air: 40 °C Relative humidity of air: 93% Duration: 56 days Test according to IEC 60068-2-78	< 20%
Rapid change of temperature	IEC 60738-1	$T = T_{LCT}$, $T = T_{UCT}$ Number of cycles: 5 Test duration: 30 min Test according to IEC 60068-2-14, Test Na	< 20%
Vibration	IEC 60738-1	Frequency: 10 - 55 - 10 Hz Displacement amplitude: 0.75 mm Test duration: 3 · 2 h Test according to IEC 60028-2-6, Test Fc	< 20%
Bump	IEC 60738-1	Pulse shape: half-sine Acceleration: 40 g Pulse duration: 6 ms; 6 · 4000 pulses Test according to IEC 60068-2-29	< 20%
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{UCT}$ Test duration: 16 h Damp heat first cycle Cold: $T = T_{LCT}$ Test duration: 2 h Damp heat 5 cycles Tests performed according to IEC 60068-2-30	< 20%

Characteristics

Typical curve of demagnetization current $I_{in,coil}$ measured at V_R
 Coil resistance: 20 Ω (T705, T209), 10 Ω (T608), 25 Ω (T250)
 Ambient temperature: 25 $^{\circ}\text{C}$

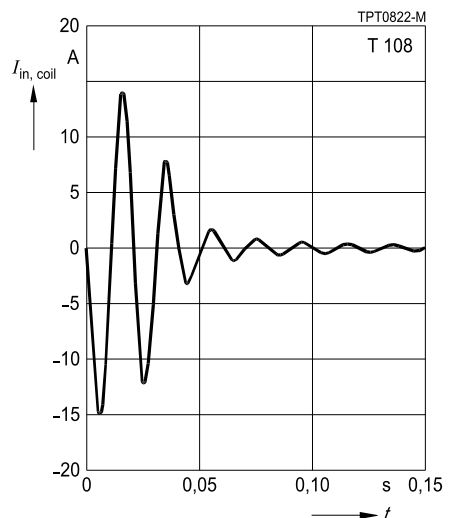
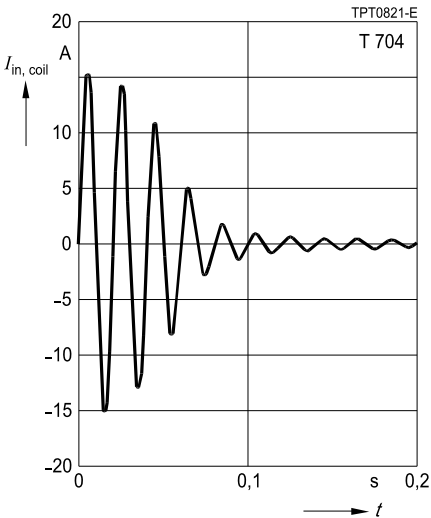
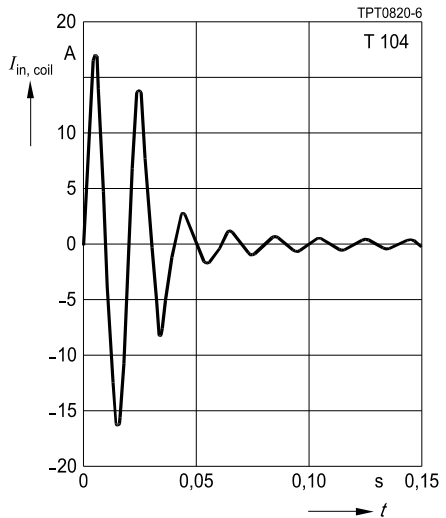
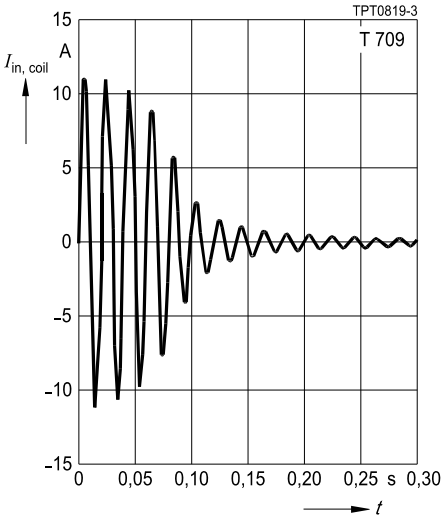


Characteristics

Typical curve of demagnetization current $I_{in,coil}$ measured at V_R

Coil resistance: 14 Ω (T709), 10 Ω (T104, T704, T108)

Ambient temperature: 25 °C



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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature $-25\text{ °C} \dots +45\text{ °C}$, relative humidity $\leq 75\%$ annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within 6 months after delivery.

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.

Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

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Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of passive electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of a passive electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of a passive electronic component.
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